



## 100 Centres Bar Clamp

Replaces DS6380-1 DS6380-2 May 2022 LN41753

## **DESCRIPTION**

Dynex offers a range of standard clamps designed to accommodate press pack semiconductors with tie rod centres from 75mm to 210mm and clamping force from 5kN to 138kN.

The set clamps use Disc Springs to DIN 2092/2093 to apply the clamping force over a wide temperature range. The clamps also incorporate pressure indicators to make installation simple. Isolation is provided by high quality ceramic insulators and PTFE sleeving.

Zinc plating with a Yellow Passivated finish is used for enhanced corrosion protection.

If a clamp you require is not available in our standard range, Dynex can provide a clamping solution to your individual needs. Speak to your local sales representative for details.

## **ORDERING INFORMATION**

**Example Part Number:** 

## DC100/20/200/R

**DC100** - Clamp Series

This is a Dynex clamp with tie rod centres of 100mm

20 - Clamping Force

This is the required clamping force of the semiconductor device in kN

200 - Dimension 'Y' (see figure 2)

This is the total height of all the parts to be clamped, plus the bottom reaction bar if fitted

R - Bottom Reaction Bar fitted (optional)

If using a heatsink of suitable strength and stiffness the bottom reaction bar is not necessary, and the 'R' can be omitted from the part number Tie Rod Centres (mm) Forces available (kN)

100 20, 22

The DC100 has been designed to support the common semiconductor packages shown below.

Dyne Outlin	x ne	Flange Diameter (mm)	Height (mm)
F		75	26.5
N		73	35.15

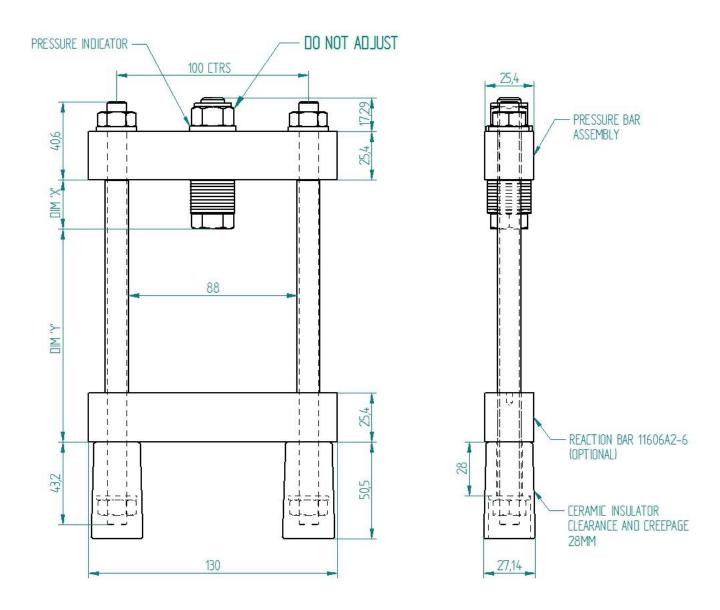


Figure 1: Clamp General Assembly



## **100 Centres Bar Clamp**

# All dimensions in mm, unless stated otherwise. **DO NOT SCALE.**



FORCE	DIM 'X'
20kN	25.22
22kN	25.31

Figure 2: Clamp Outline



## **DC100**

## 100 Centres Bar Clamp

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The products are not intended for use in applications where a failure or malfunction may cause loss of life, injury or damage to property. The user must ensure that appropriate safety precautions are taken to prevent or mitigate the consequences of a product failure or malfunction.

The products must not be touched when operating because there is a danger of electrocution or severe burning. Always use protective safety equipment such as appropriate shields for the product and wear safety glasses. Even when disconnected any electric charge remaining in the product must be discharged and allowed to cool before safe handling using protective gloves.

Extended exposure to conditions outside the product ratings may affect reliability leading to premature product failure. Use outside the product ratings is likely to cause permanent damage to the product. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture, a large current to flow or high voltage arcing, resulting in fire or explosion. Appropriate application design and safety precautions should always be followed to protect persons and property.

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design work on the product has been started.

Provisional Information: Some initial development work has been performed. The datasheet represents a view of the end

product based on very limited information. Certain details will change.

Preliminary Information: The product design is complete and final characterisation for volume production is in progress. The

datasheet represents the product as it is now understood but details may change.

No Annotation: The product has been approved for production and unless otherwise notified by Dynex any product

ordered will be supplied to the current version of the data sheet prevailing at the time of our order

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